

Title (en)  
LINKER COMPOUNDS COMPRISING AMIDE BONDS

Title (de)  
LINKERVERBINDUNGEN MIT AMIDBINDUNGEN

Title (fr)  
COMPOSÉS LIEURS COMPRENANT DES LIAISONS AMIDE

Publication  
**EP 4228671 A1 20230823 (EN)**

Application  
**EP 21881131 A 20211014**

Priority  
• US 202063093062 P 20201016  
• US 2021055085 W 20211014

Abstract (en)  
[origin: WO2022081911A1] Various embodiments provide a homo-bivalent linker compound comprising identical functional groups at either end, methods of making such linker compounds, and methods of using the linker compounds.

IPC 8 full level  
**A61K 38/16** (2006.01); **C07K 1/22** (2006.01); **C07K 14/00** (2006.01)

CPC (source: EP IL KR US)  
**A61K 31/713** (2013.01 - KR); **A61K 47/55** (2017.07 - EP IL); **A61K 47/65** (2017.07 - EP IL KR US); **A61K 48/0033** (2013.01 - KR); **C07K 5/06026** (2013.01 - EP IL KR US); **C07K 5/06052** (2013.01 - EP IL KR US); **C07K 5/06086** (2013.01 - EP IL KR US); **C07K 5/06113** (2013.01 - EP IL KR US); **C07K 5/06165** (2013.01 - US); **C07K 5/1008** (2013.01 - EP IL KR US)

Citation (search report)  
See references of WO 2022081911A1

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)  
BA ME

Designated validation state (EPC)  
KH MA MD TN

DOCDB simple family (publication)  
**WO 2022081911 A1 20220421**; AU 2021361007 A1 20230601; CA 3195615 A1 20220421; CN 116568698 A 20230808; EP 4228671 A1 20230823; IL 302083 A 20230601; JP 2023546558 A 20231106; KR 20230087538 A 20230616; MX 2023004320 A 20230504; US 2023390408 A1 20231207

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**US 2021055085 W 20211014**; AU 2021361007 A 20211014; CA 3195615 A 20211014; CN 202180083397 A 20211014; EP 21881131 A 20211014; IL 30208323 A 20230413; JP 2023521475 A 20211014; KR 20237015840 A 20211014; MX 2023004320 A 20211014; US 202118032118 A 20211014